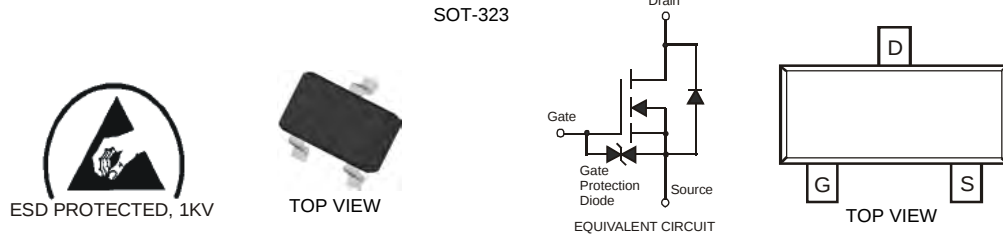


## Features

- Low On-Resistance
- Low Gate Threshold Voltage
- Low Input Capacitance
- Fast Switching Speed
- Small Surface Mount Package
- ESD Protected Gate, 1KV (HBM)
- **Lead Free/RoHS Compliant (Note 2)**
- **Qualified to AEC-Q101 Standards for High Reliability**

## Mechanical Data

- Case: SOT-323
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020D
- Terminals: Solderable per MIL-STD-202, Method 208
- Lead Free Plating (Matte Tin Finish annealed over Alloy 42 leadframe).
- Terminal Connections: See Diagram
- Marking Information: See Page 3
- Ordering Information: See Page 3
- Weight: 0.006 grams (approximate)



## Maximum Ratings @T<sub>A</sub> = 25°C unless otherwise specified

| Characteristic               | Symbol           | Value              | Units |
|------------------------------|------------------|--------------------|-------|
| Drain-Source Voltage         | V <sub>DSS</sub> | 60                 | V     |
| Gate-Source Voltage (Note 1) | V <sub>GSS</sub> | ±20                | V     |
| Drain Current (Note 1)       | I <sub>D</sub>   | 115<br>73<br>800   | mA    |
|                              |                  | Continuous         |       |
|                              |                  | Continuous @ 100°C |       |
|                              |                  | Pulsed             |       |

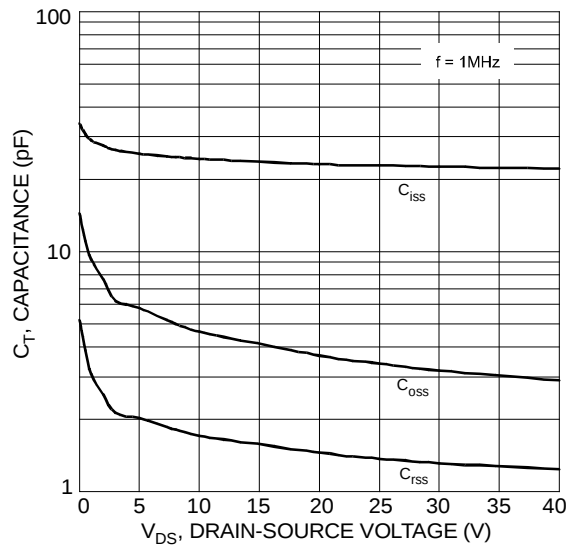
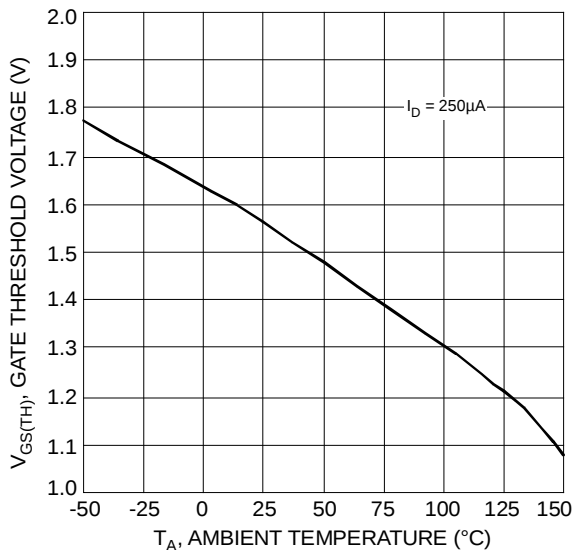
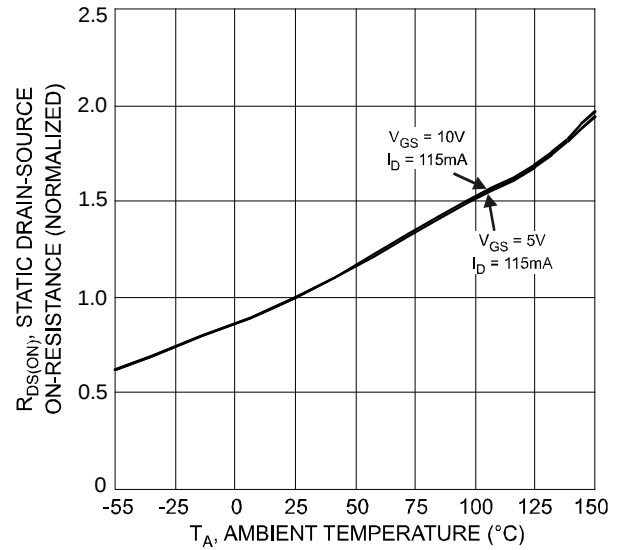
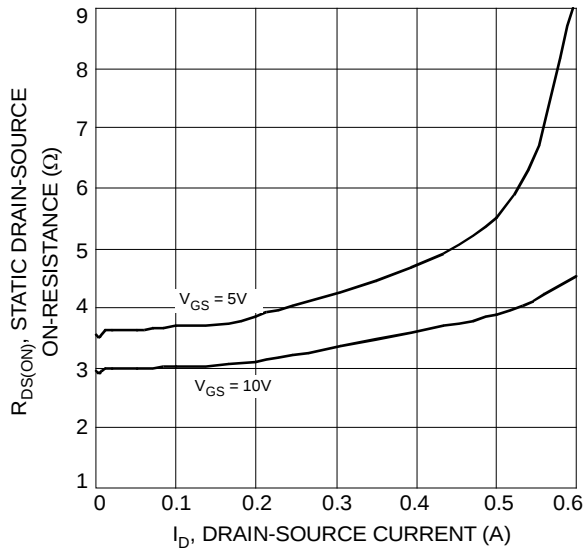
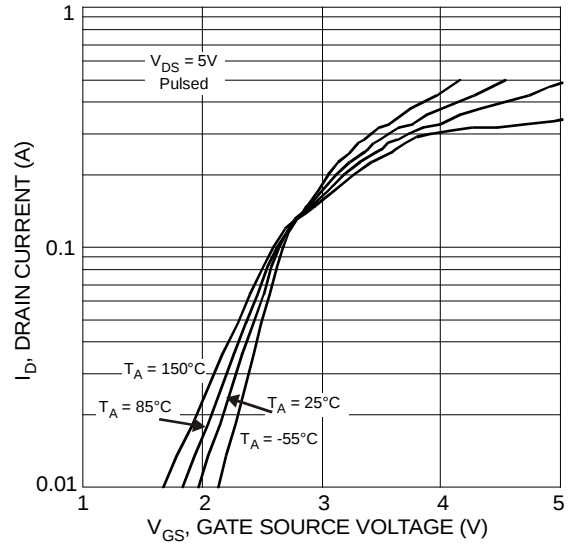
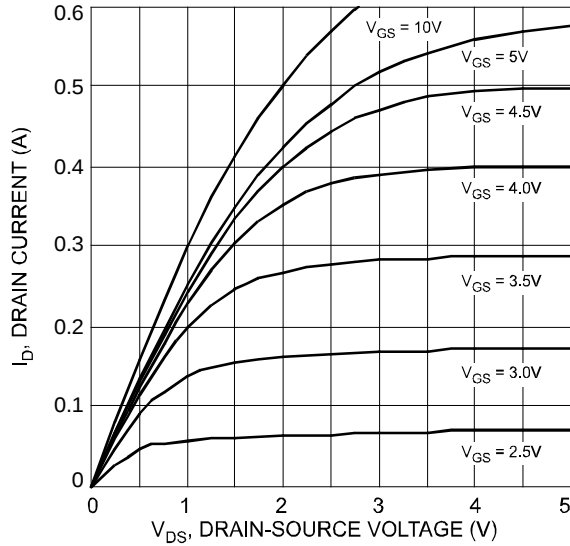
## Thermal Characteristics @T<sub>A</sub> = 25°C unless otherwise specified

| Characteristic                          | Symbol                            | Value       | Units |
|-----------------------------------------|-----------------------------------|-------------|-------|
| Total Power Dissipation                 | P <sub>D</sub>                    | 200         | mW    |
| Thermal Resistance, Junction to Ambient | R <sub>θJA</sub>                  | 625         | °C/W  |
| Operating and Storage Temperature Range | T <sub>J</sub> , T <sub>STG</sub> | -55 to +150 | °C    |

## Electrical Characteristics @T<sub>A</sub> = 25°C unless otherwise specified

| Characteristic                    | Symbol              | Min | Typ        | Max        | Unit | Test Condition                                                                                                                                           |
|-----------------------------------|---------------------|-----|------------|------------|------|----------------------------------------------------------------------------------------------------------------------------------------------------------|
| OFF CHARACTERISTICS (Note 3)      |                     |     |            |            |      |                                                                                                                                                          |
| Drain-Source Breakdown Voltage    | BV <sub>DSS</sub>   | 60  | 70         | —          | V    | V <sub>GS</sub> = 0V, I <sub>D</sub> = 10μA                                                                                                              |
| Zero Gate Voltage Drain Current   | I <sub>DSS</sub>    | —   | —          | 1.0<br>500 | μA   | @ T <sub>C</sub> = 25°C<br>@ T <sub>C</sub> = 125°C<br>V <sub>DS</sub> = 60V, V <sub>GS</sub> = 0V                                                       |
| Gate-Body Leakage                 | I <sub>GSS</sub>    | —   | —          | ±5         | μA   | V <sub>GS</sub> = ±20V, V <sub>DS</sub> = 0V                                                                                                             |
| ON CHARACTERISTICS (Note 3)       |                     |     |            |            |      |                                                                                                                                                          |
| Gate Threshold Voltage            | V <sub>GS(th)</sub> | 1.2 | —          | 2.0        | V    | V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 250μA                                                                                               |
| Static Drain-Source On-Resistance | R <sub>DS(ON)</sub> | —   | 3.5<br>3.0 | 6<br>5     | Ω    | @ T <sub>J</sub> = 25°C<br>@ T <sub>J</sub> = 125°C<br>V <sub>GS</sub> = 5.0V, I <sub>D</sub> = 0.115A<br>V <sub>GS</sub> = 10V, I <sub>D</sub> = 0.115A |
| Forward Transconductance          | g <sub>FS</sub>     | 80  | —          | —          | mS   | V <sub>DS</sub> = 10V, I <sub>D</sub> = 0.115A                                                                                                           |
| DYNAMIC CHARACTERISTICS           |                     |     |            |            |      |                                                                                                                                                          |
| Input Capacitance                 | C <sub>iSS</sub>    | —   | 23         | —          | pF   | V <sub>DS</sub> = 25V, V <sub>GS</sub> = 0V, f = 1.0MHz                                                                                                  |
| Output Capacitance                | C <sub>oSS</sub>    | —   | 3.4        | —          | pF   |                                                                                                                                                          |
| Reverse Transfer Capacitance      | C <sub>rSS</sub>    | —   | 1.4        | —          | pF   |                                                                                                                                                          |
| SWITCHING CHARACTERISTICS         |                     |     |            |            |      |                                                                                                                                                          |
| Turn-On Delay Time                | t <sub>D(ON)</sub>  | —   | 10         | —          | ns   | V <sub>DD</sub> = 30V, I <sub>D</sub> = 0.115A, R <sub>L</sub> = 150Ω,                                                                                   |
| Turn-Off Delay Time               | t <sub>D(OFF)</sub> | —   | 33         | —          | ns   | V <sub>GEN</sub> = 10V, R <sub>GEN</sub> = 25Ω                                                                                                           |

- Notes:
1. Device mounted on FR-4 PCB, 1 inch x 0.85 inch x 0.062 inch; pad layout as shown on Diodes Inc. suggested pad layout document AP02001, which can be found on our website at <http://www.diodes.com/datasheets/ap02001.pdf>.
  2. No purposefully added lead.
  3. Short duration pulse test used to minimize self-heating effect.



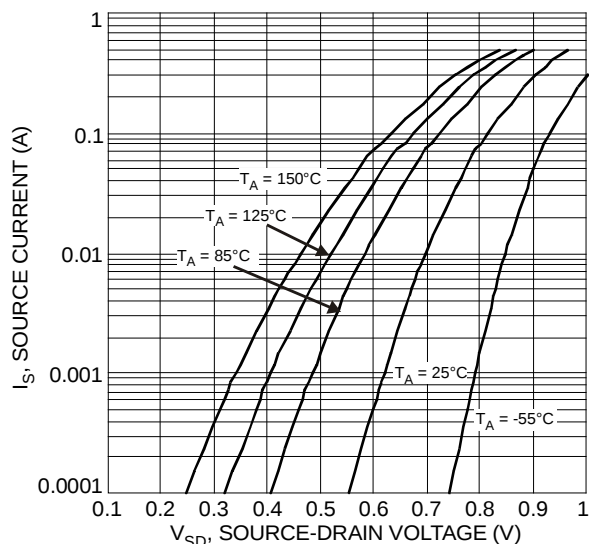


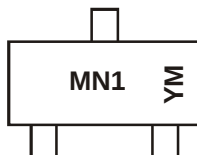
Fig. 7 Reverse Drain Current vs. Source-Drain Voltage

## Ordering Information (Note 4)

| Part Number | Case    | Packaging        |
|-------------|---------|------------------|
| DMN66D0LW-7 | SOT-323 | 3000/Tape & Reel |

 Notes: 4. For packaging details, go to our website at <http://www.diodes.com/datasheets/ap02007.pdf>.

## Marking Information



MN1 = Product Type Marking Code  
 YM = Date Code Marking  
 Y = Year ex: V = 2008  
 M = Month ex: 9 = September

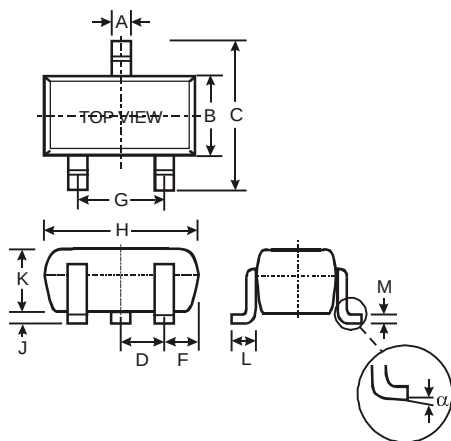
### Date Code Key

| Year | 2008 | 2009 | 2010 | 2011 | 2012 | 2013 | 2014 | 2015 |
|------|------|------|------|------|------|------|------|------|
| Code | V    | W    | X    | Y    | Z    | A    | B    | C    |

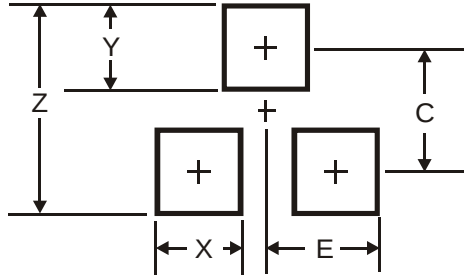
| Month | Jan | Feb | Mar | Apr | May | Jun | Jul | Aug | Sep | Oct | Nov | Dec |
|-------|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|
| Code  | 1   | 2   | 3   | 4   | 5   | 6   | 7   | 8   | 9   | O   | N   | D   |

## Package Outline Dimensions



| SOT-323              |      |      |       |
|----------------------|------|------|-------|
| Dim                  | Min  | Max  | Typ   |
| A                    | 0.25 | 0.40 | 0.30  |
| B                    | 1.15 | 1.35 | 1.30  |
| C                    | 2.00 | 2.20 | 2.10  |
| D                    | -    | -    | 0.65  |
| F                    | 0.30 | 0.40 | 0.425 |
| G                    | 1.20 | 1.40 | 1.30  |
| H                    | 1.80 | 2.20 | 2.15  |
| J                    | 0.0  | 0.10 | 0.05  |
| K                    | 0.90 | 1.00 | 1.00  |
| L                    | 0.25 | 0.40 | 0.30  |
| M                    | 0.10 | 0.18 | 0.11  |
| $\alpha$             | 0°   | 8°   | -     |
| All Dimensions in mm |      |      |       |

## Suggested Pad Layout



| Dimensions | Value (in mm) |
|------------|---------------|
| Z          | 2.8           |
| X          | 0.7           |
| Y          | 0.9           |
| C          | 1.9           |
| E          | 1.0           |

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